BLF6G27-135; BLF6G27LS-135

WiMAX power LDMOS transistor

AMPLEON

Rev. 3 — 1 September 2015

Product data sheet

1. Product profile

1.1 General description

135 W LDMOS power transistor for base station applications at frequencies from 2500 MHz to 2700 MHz.

Table 1. Typical performance

Typical RF performance at $T_{case} = 25$ °C in a class-AB production test circuit.

Mode of operation	f	V _{DS}	P _{L(AV)}	P _{L(p)}	Gp	η_{D}	ACPR _{885k}	ACPR _{1980k}
	(MHz)	(V)	(W)	(W)	(dB)	(%)	(dBc)	(dBc)
1-carrier N-CDMA[1]	2500 to 2700	32	20	200	16	22.5	-52 ^[2]	-67 <mark>2</mark>

^[1] Single carrier IS-95 with pilot, paging, sync and 6 traffic channels (Walsh codes 8 to 13). PAR = 9.7 dB at 0.01 % probability on the CCDF. Channel bandwidth is 1.2288 MHz.

1.2 Features

- Typical 1-carrier N-CDMA performance (Single carrier IS-95 with pilot, paging, sync and 6 traffic channels [Walsh codes 8 to 13]. PAR = 9.7 dB at 0.01 % probability on the CCDF. Channel bandwidth is 1.2288 MHz) at a frequency of 2500 MHz and 2700 MHz, a supply voltage of 32 V and an I_{Dg} of 1200 mA:
 - Average output power = 20 W
 - ◆ Power gain = 16 dB
 - ◆ Drain efficiency = 22.5 %
 - ◆ ACPR_{885k} = -52.0 dBc in 30 kHz bandwidth
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (2500 MHz to 2700 MHz)
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

■ RF power amplifiers for base stations and multicarrier applications in the 2500 MHz to 2700 MHz frequency range

^[2] Measured within 30 kHz bandwidth.

2. Pinning information

Table 2. Pinning

	Filling		
Pin	Description	Simplified outline	Graphic symbol
BLF6G27	-135 (SOT502A)		
1	drain		
2	gate		1
3	source	[1] \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	2
		2	3 sym112
BLF6G27	LS-135 (SOT502B)		<i>5,2</i>
1	drain		
2	gate	1	1
3	source	<u>[1]</u>	2
		2	3
			sym112

^[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BLF6G27-135	-	flanged LDMOST ceramic package; 2 mounting holes; 2 leads	SOT502A		
BLF6G27LS-135	-	earless flanged LDMOST ceramic package; 2 leads	SOT502B		

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		-0.5	+13	V
I _D	drain current		-	34	Α
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	200	°C

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Туре	Тур	Unit
$R_{th(j\text{-case})}$	thermal resistance from	T_{case} = 80 °C;	BLF6G27-135	0.5	K/W
	junction to case	$P_{L} = 135 \text{ W (CW)}$	BLF6G27LS-135	0.45	K/W

BLF6G27-135_BLF6G27LS-135#3

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6. Characteristics

Table 6. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 0.5 \text{ mA}$	65	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	V_{DS} = 10 V; I_{D} = 216 mA	1.4	2	2.4	V
I _{DSS}	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V}$	-	-	4.2	μΑ
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 V;$ $V_{DS} = 10 V$	30.6	34	-	Α
I _{GSS}	gate leakage current	V_{GS} = +11 V; V_{DS} = 0 V	_	-	420	nA
g _{fs}	forward transconductance	$V_{DS} = 10 \text{ V}; I_D = 6.3 \text{ A}$	-	12	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 7.2 A$	-	0.085	0.135	Ω
C _{rs}	feedback capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V};$ f = 1 MHz	-	3.15	-	pF

7. Application information

Table 7. Application information

Mode of operation: 1-carrier N-CDMA, single carrier IS-95 with pilot, paging, sync and 6 traffic channels (Walsh codes 8 to 13). PAR = 9.7 dB at 0.01 % probability on the CCDF, channel bandwidth is 1.2288 MHz; f_1 = 2500 MHz; f_2 = 2600 MHz; f_3 = 2700 MHz; RF performance at V_{DS} = 32 V; I_{Dq} = 1200 mA; T_{case} = 25 °C; unless otherwise specified, in a class-AB production circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	$P_{L(AV)} = 20 W$	14	16	-	dB
RLin	input return loss	$P_{L(AV)} = 20 W$	-	-10	-	dB
η_{D}	drain efficiency	$P_{L(AV)} = 20 W$	19.0	22.5	-	%
ACPR _{885k}	adjacent channel power ratio (885 kHz)	$P_{L(AV)} = 20 W$	<u>[1]</u> –48	-52	-	dBc
ACPR _{1980k}	adjacent channel power ratio (1980 kHz)	$P_{L(AV)} = 20 W$	<u>[1]</u> –65	-67	-	dBc
P _{L(M)}	peak output power		² 185	200	-	W

^[1] Measured within 30 kHz bandwidth.

7.1 Ruggedness in class-AB operation

The BLF6G27-135 and BLF6G27LS-135 are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: $V_{DS} = 28 \text{ V}$; $I_{Dq} = 1200 \text{ mA}$; $P_L = P_{L(1dB)}$; f = 2700 MHz.

^[2] Measured at 2.7 GHz and 3 dB compression of the CCDF at 0.01 % probability.

7.2 Ampleon WiMAX signal

7.2.1 WiMAX signal description

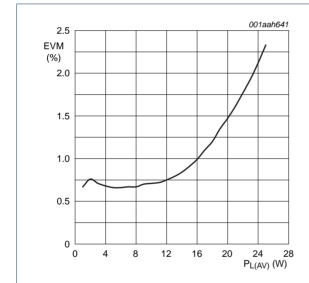
frame duration = 5 ms; bandwidth = 10 MHz; sequency = 1 frame; frequency band = WCS; sampling rate = 11.2 MHz; n = 28 / 25; G = T_g / T_b = 1 / 8; FFT = 1024; zone type = PUSC; δ = 97.7 %; number of symbols = 46; number of subchannels = 30; PAR = 9.5 dB.

Preamble: 1 symbol \times 30 subchannels; $P_L = P_{L(nom)} + 3.86$ dB.

Table 8. Frame structure

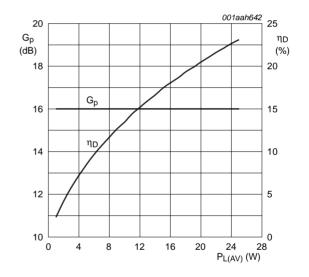
Frame contents		s	Modulation technique	Data length
Zone 0	FCH	$2 \ \text{symbols} \times 4 \ \text{subchannels}$	QPSK1/2	3 bit
Zone 0	data	2 symbols \times 26 subchannels	64QAM3/4	692 bit
Zone 0	data	44 symbols × 30 subchannels	64QAM3/4	10000 bit

7.2.2 Graphs



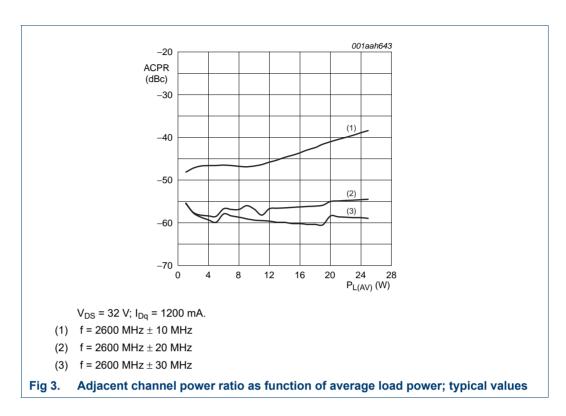
 V_{DS} = 32 V; I_{Dq} = 1200 mA; f = 2600 MHz. Fig 1. **EVM** as function of average load power;

typical values



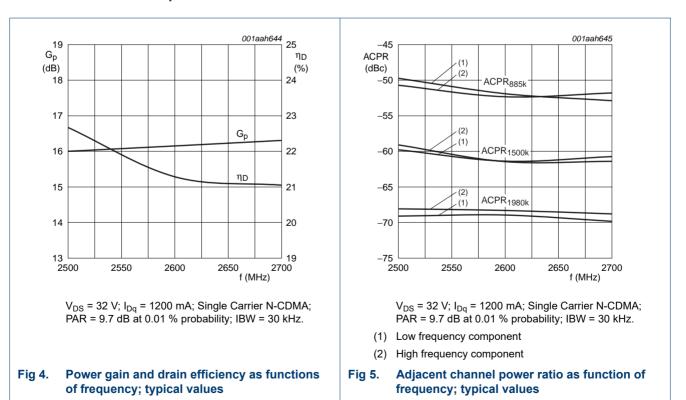
 V_{DS} = 32 V; I_{Dq} = 1200 mA; f = 2600 MHz.

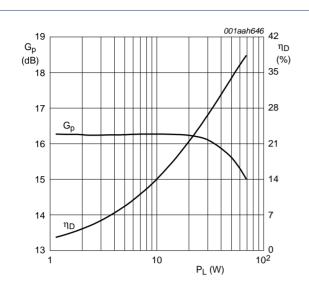
Fig 2. Power gain and drain efficiency as functions of average load power; typical values



7.3 Single carrier N-CDMA broadband performance at 9 W average

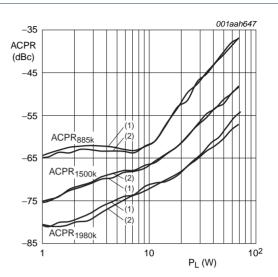
7.3.1 Graphs





 V_{DS} = 32 V; I_{Dq} = 1200 mA; f = 2600 MHz; Single Carrier N-CDMA; PAR = 9.7 dB at 0.01 % probability; Channel Bandwidth = 1.23 MHz; IBW = 30 kHz.

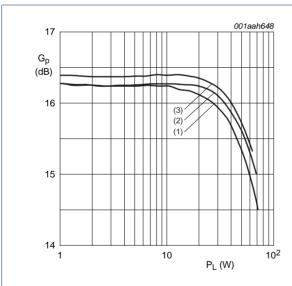
Fig 6. Power gain and drain efficiency as functions of load power; typical values



 V_{DS} = 32 V; I_{Dq} = 1200 mA; f = 2600 MHz; Single Carrier N-CDMA; PAR = 9.7 dB at 0.01 % probability; Channel Bandwidth = 1.23 MHz; IBW = 30 kHz.

- (1) Low frequency component
- (2) High frequency component

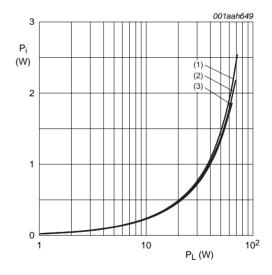
Fig 7. Adjacent channel power ratio as function of load power; typical values



 V_{DS} = 32 V; I_{Dq} = 1200 mA; Single Carrier N-CDMA; PAR = 9.7 dB at 0.01 % probability; Channel Bandwidth = 1.23 MHz; IBW = 30 kHz.

- (1) f = 2500 MHz
- (2) f = 2600 MHz
- (3) f = 2700 MHz

Fig 8. Power gain as function of load power; typical values

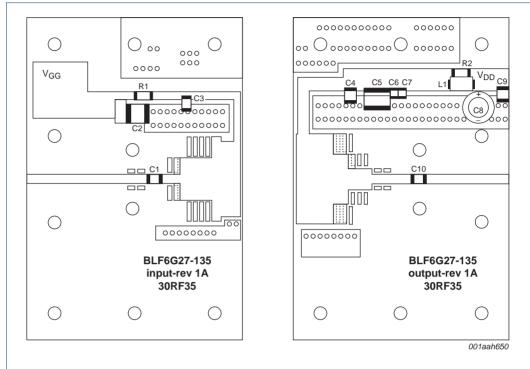


 V_{DS} = 32 V; I_{Dq} = 1200 mA; Single Carrier N-CDMA; PAR = 9.7 dB at 0.01 % probability; Channel Bandwidth = 1.23 MHz; IBW = 30 kHz.

- (1) f = 2500 MHz
- (2) f = 2600 MHz
- (3) f = 2700 MHz

Fig 9. Input power as function of load power; typical values

8. Test information



Striplines are on a double copper-clad Taconic RF35 Printed-Circuit Board (PCB) with ϵ_{r} = 3.5 and thickness = 0.76 mm.

See Table 9 for list of components.

Fig 10. Component layout for 2500 MHz to 2700 MHz test circuit

Table 9. List of components For test circuit, see Figure 10.

Component	Description	Value	Remarks
C1, C3, C4, C10	multilayer ceramic chip capacitor	8.2 pF	ATC 100B or equivalent
C2	multilayer ceramic chip capacitor	4.7 μF; 50 V	TDK C4532X7R1H475M or equivalent
C5	multilayer ceramic chip capacitor	10 μF; 50 V	TDK C5750X7R1H106M or equivalent
C9	multilayer ceramic chip capacitor	1.5 μF; 50 V	TDK C3225X7R1H155M or equivalent
C6, C7	multilayer ceramic chip capacitor	100 nF	Vishay VJ1206Y104KXB or equivalent
C8	electrolytic capacitor	470 μF; 63 V	ATC 100B or equivalent
L1	ferrite SMD bead	-	Ferroxcube BDS 3/3/4.6-4S2 or equivalent
R1	SMD resistor	5.1 Ω	SMD 1206
R2	SMD resistor	9.1 Ω	SMD 1206

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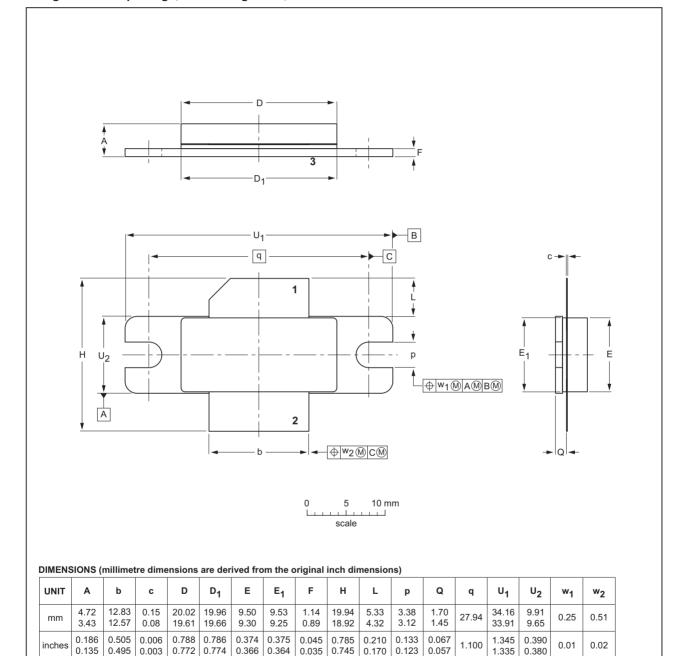
Table 10. Measured test circuit impedances

f	Z _i	Z _o
(GHz)	(Ω)	(Ω)
2.5	1.60 + j1.07	1.44 + j1.86
2.6	1.38 + j2.08	1.17 + j2.80
2.7	1.17 + j2.77	0.97 + j3.41

9. Package outline

Flanged ceramic package; 2 mounting holes; 2 leads

SOT502A

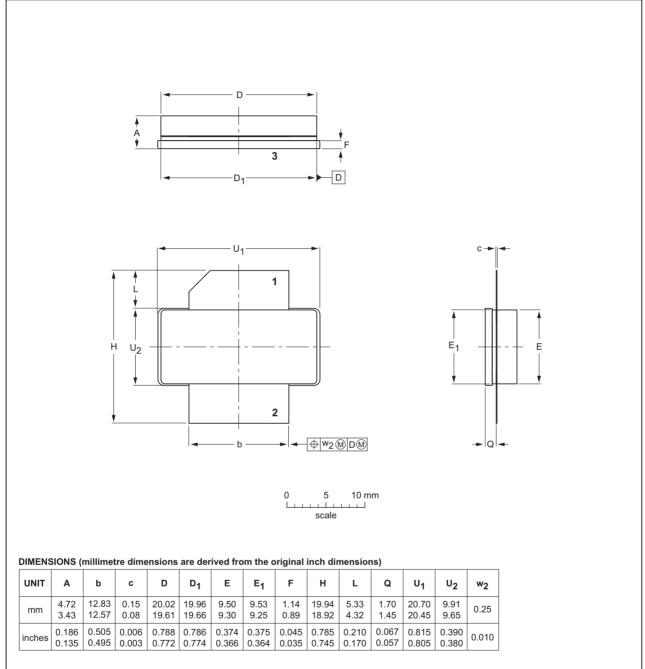


OUTLINE	INE REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT502A						-03-01-10- 12-05-02

Fig 11. Package outline SOT502A



SOT502B



 OUTLINE VERSION
 REFERENCES
 EUROPEAN PROJECTION
 ISSUE DATE

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Fig 12. Package outline SOT502B

10. Abbreviations

Table 11. Abbreviations

Acronym	Description
CCDF	Complementary Cumulative Distribution Function
CDMA	Code Division Multiple Access
CW	Continuous Wave
EVM	Error Vector Magnitude
FCH	Frame Control Header
FFT	Fast Fourier Transform
IBW	Instantaneous BandWidth
IS-95	CDMA Interim Standard 95
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor
N-CDMA	Narrowband Code Division Multiple Access
PAR	Peak-to-Average power Ratio
PUSC	Partial Usage of SubChannels
RF	Radio Frequency
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio
WCS	Wireless Communications Service
WiMAX	Worldwide Interoperability for Microwave Access

11. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BLF6G27-135_BLF6G27LS-135#3	20150901	Product data sheet	-	BLF6G27-135_ BLF6G27LS-135_2	
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. Legal texts have been adapted to the new company name where appropriate. 				
BLF6G27-135_BLF6G27LS-135_2	20080526	Product data sheet	-	BLF6G27-135_ BLF6G27LS-135_1	
BLF6G27-135_BLF6G27LS-135_1	20080221	Preliminary data sheet	-	-	

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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